Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	87	(David near2 O'Meara).in. (Gerrit near2 Leusink).in. (Stephen near2 Cabral).in. (Anthony near2 Dip).in. (Cory near2 Wajda).in. (Raymond near2 Joe).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:38
L3	0	L2 and ((carbon near4 fibre\$2) same (groove\$2 recess\$2 channel\$2 slot\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:39
L4	0	L2 and ((carbon near4 element\$2) same (groove\$2 recess\$2 channel\$2 slot\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:39
L5	0	L2 and ((plural\$3 near4 (heat\$3 near3 element\$2)) same (groove\$2 recess\$2 channel\$2 slot\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:41
L6	20807	(Tokyo near2 electron).as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:41
L7	4	6 and ((plural\$3 near4 (heat\$3 near3 element\$2)) same (groove\$2 recess\$2 channel\$2 slot\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:55
L8	15	(carbon near3 wire near5 heater) same (fiber same quartz)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:56
S1	2	"20050217799"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/10 09:37

S2	87	(David near2 O'Meara).in. (Gerrit near2 Leusink).in. (Stephen near2 Cabral).in. (Anthony near2 Dip).in. (Cory near2 Wajda).in. (Raymond near2 Joe).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/09 10:25
S3	. 40	S2 and ((substrate wafer) near5 heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/09 10:37
S4	2	S2 and ((substrate wafer) near5 (heat\$4 and carbon))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/09 10:26
S5	187385	((substrate wafer) near5 (heat\$4 temperature))	US-PGPUB; USPAT	OR	ON	2006/06/09 10:38
S6	64179	S5 and (118/725 156/345.52 "315"/\$ 118/724 "427"/\$ "438"/\$ "204"/\$ "216"/\$).ccls.	US-PGPUB; USPAT	OR	ON	2006/06/09 17:50
S7	92	S6 and ((carbon near4 heat\$3) same tub\$3)	US-PGPUB; USPAT	OR	ON	2006/06/09 10:41
S8	85	S7 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 15:04
S9	2	(carbon near3 fibre\$2) near4 (heat same tub\$3)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:11
S10	4	(carbon near3 fibre\$2) near4 (heat\$3 same tub\$3)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:12
S11	13	(carbon near3 fibre\$2) near6 (heat\$3 near4 (assembl\$3 unit\$2 element\$2))	US-PGPUB; USPAT	OR	ON	2006/06/09 11:16
S12	7	(carbon near3 fibre\$2) near6 (heating near2 element\$2)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:35
S13	26429	(wire near2 heat\$3)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:18
S14	48	S13 and (carbon near2 fibre\$2)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:19
S15	47	S14 not S11	US-PGPUB; USPAT	OR	ON	2006/06/09 11:19
S16	3	(carbon near3 nanotube\$2) near6 (heating near2 element\$2)	US-PGPUB; USPAT	OR	ON	2006/06/09 11:36

S17	2	"20010049080"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/09 11:52
S18	2988	(118/725 156/345.52 118/724 315/638).ccls.	US-PGPUB; USPAT	OR	ON	2006/06/09 12:12
S19	2091	(118/725 156/345.52).ccls.	US-PGPUB; USPAT	OR	ON	2006/06/09 12:13
S20	2577	S18 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 12:13
S21	1763	S19 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 12:15
S22	93	S20 and (element\$2 near6 (groove\$2 channel\$2 recess\$2))	US-PGPUB; USPAT	OR	ON	2006/06/09 13:14
S23	25	S20 and ((element\$2 near6 (groove\$2 channel\$2 recess\$2) same plural\$3))	US-PGPUB; USPAT	OR	ON	2006/06/09 18:49
S24	129192	(wafer substrate) near5 heat\$3	US-PGPUB; USPAT	OR	ON	2006/06/09 15:01
S25	1939	S24 and ((plural\$4 near5 heat\$3) and (plural\$4 near5 (recess\$2 channel\$2 groove\$2)))	US-PGPUB; USPAT	OR	ON	2006/06/09 15:06
S26	1125	S24 and ((plural\$4 near2 heat\$3) and (plural\$4 near3 (recess\$2 channel\$2 groove\$2)))	US-PGPUB; USPAT	OR	ON	2006/06/09 15:03
S27	1027	S26 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 17:55
S28	251	S27 and carbon	US-PGPUB; USPAT	OR	ON	2006/06/09 15:06
S29	872	S24 and ((plural\$4 near5 heat\$3) same (plural\$4 near5 (recess\$2 channel\$2 groove\$2)))	US-PGPUB; USPAT	OR	ON	2006/06/09 15:06
S30	777	S29 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 15:06
S31	186	S30 and carbon	US-PGPUB; USPAT	OR	ON	2006/06/09 15:06
S32	525	(substrate wafer) and ((heating near2 elements) same (groove\$2 recess\$2 channel\$2))	EPO; JPO; DERWENT	OR	ON	2006/06/09 17:33
S33	98	S32 and plural\$3	EPO; JPO; DERWENT	OR	ON	2006/06/09 17:42
S34	34	plasma and ((heating near2 element) same tube\$2)	EPO; JPO; DERWENT	OR	ON	2006/06/09 17:49

S35	312339	(118/725 156/345.52 "315"/\$ 118/724 "427"/\$ "438"/\$ "204"/\$ "216"/\$).ccls.	US-PGPUB; USPAT	OR	ON	2006/06/09 17:53
S36	6001	S35 and (((wafer substrate) near6 heat\$4) and ((thermal barrier) same cool\$3))	US-PGPUB; USPAT	OR	ON	2006/06/09 17:54
S37	182	S35 and (((wafer substrate) near6 heat\$4) and ((thermal near3 barrier) same cool\$3))	US-PGPUB; USPAT	OR	ON	2006/06/09 17:55
S38	167	S37 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 18:42
S39	296	(substrate near (holder support susceptor chuck)) same (temperature near (sensor detector))	US-PGPUB; USPAT	OR	ON	2006/06/09 18:41
S40	31	S39 and (156/345.52.ccls. 118/725. ccls.)	US-PGPUB; USPAT	OR	ON	2006/06/09 18:41
S41	31	S40 and @ad<"20040331"	US-PGPUB; USPAT	OR	ON	2006/06/09 18:43
S42	31	S41 and heat\$3	US-PGPUB; USPAT	OR	ON	2006/06/09 18:44
S43	28	S31 and (temperature near3 (sensor detector))	US-PGPUB; USPAT	OR	ON	2006/06/09 18:52
544	22	S22 and (temperature near3 (sensor detector))	US-PGPUB; USPAT	OR	ON	2006/06/09 18:52